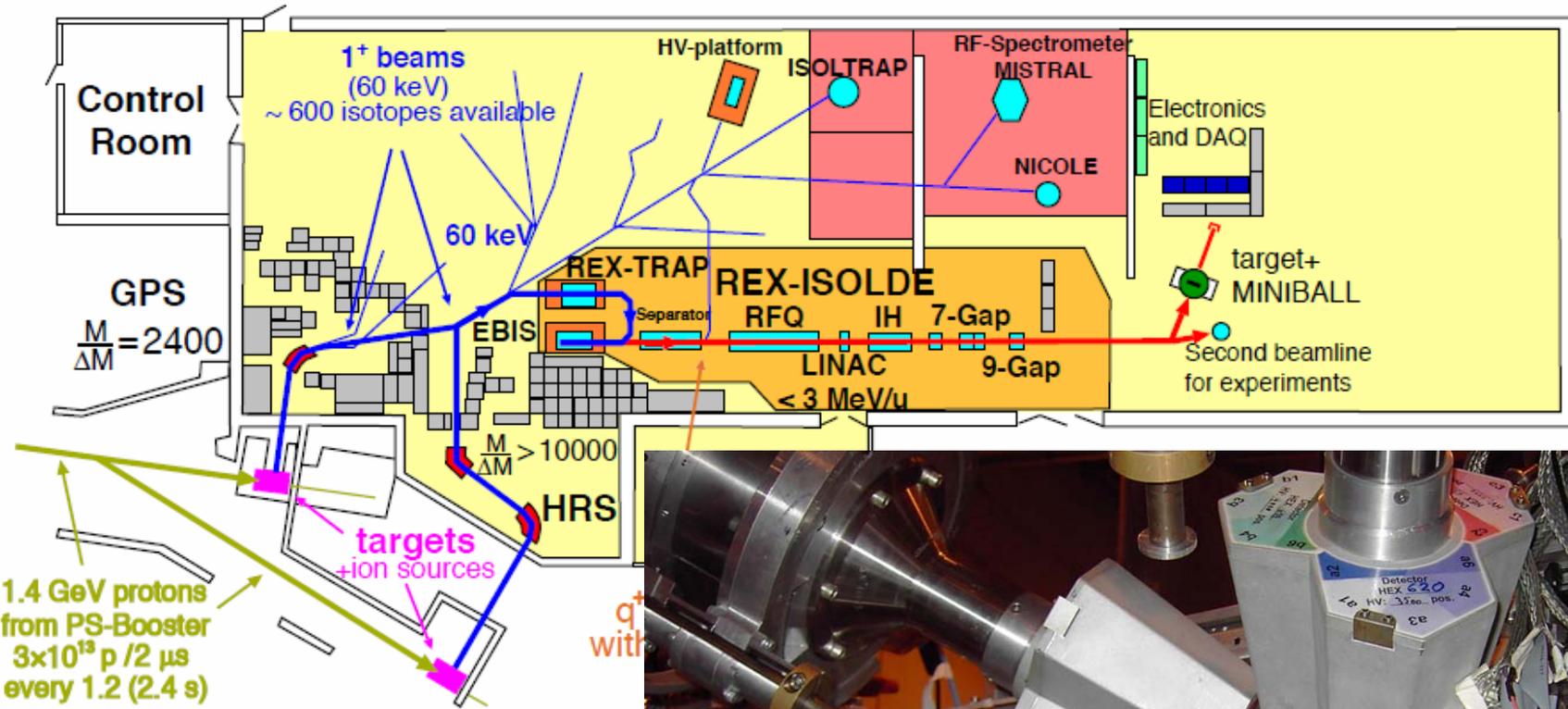


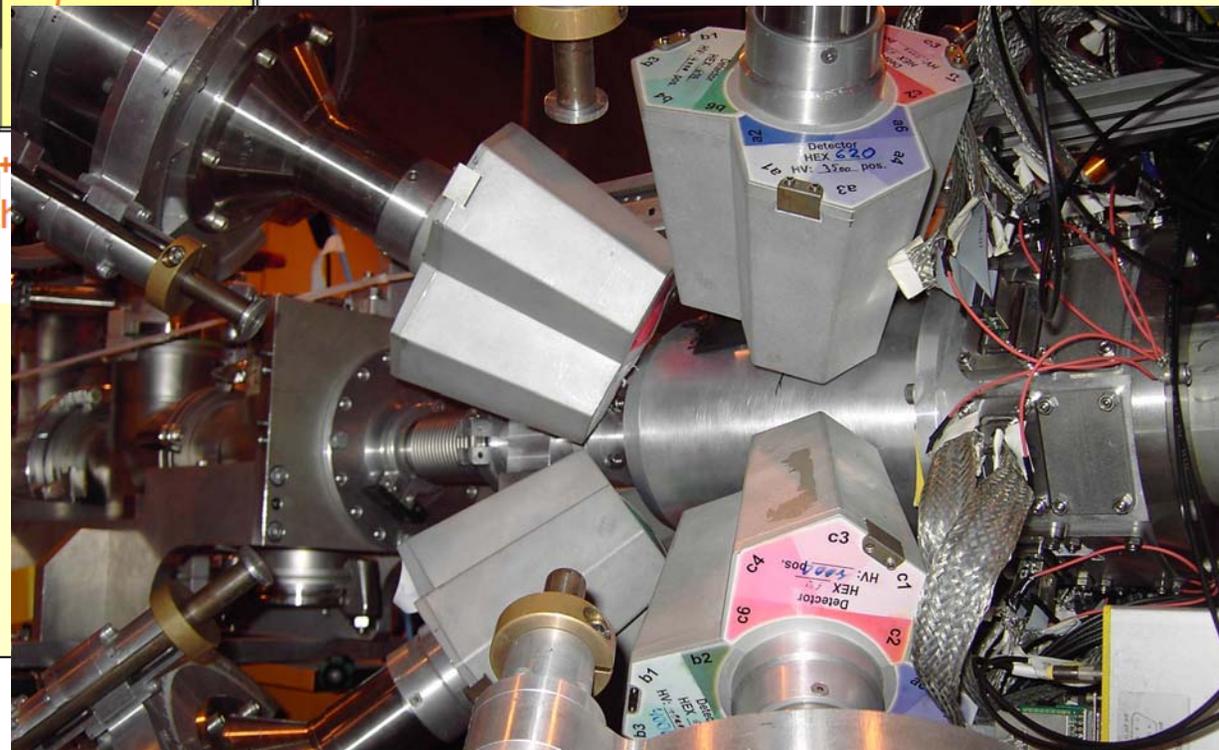
High Rate Diamond Detectors for Heavy Ions

Roman Gernhäuser, TU-München

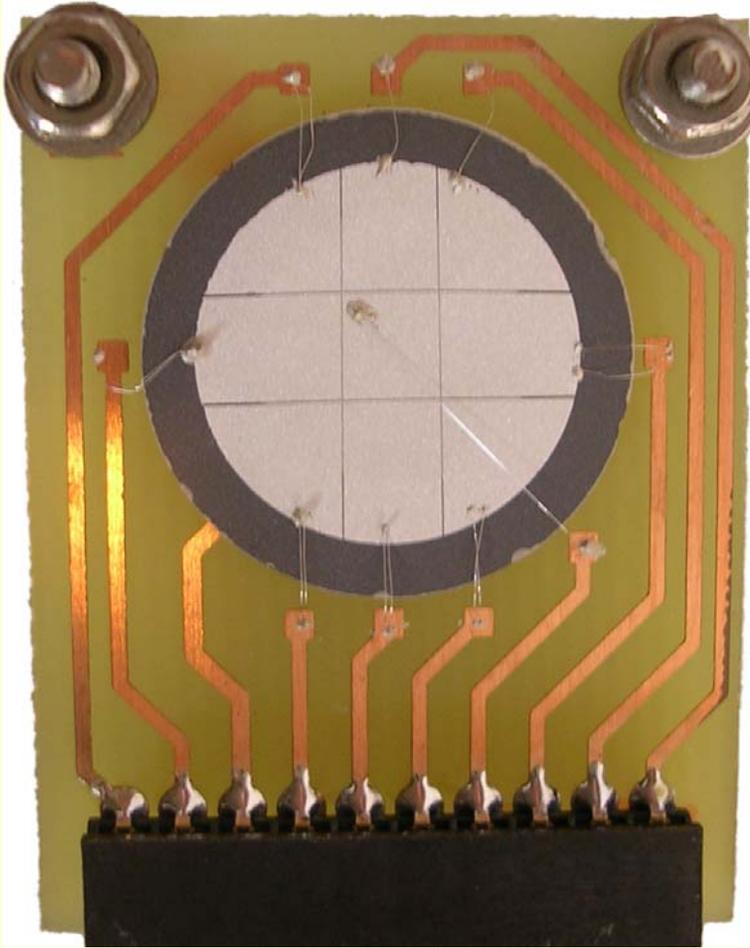
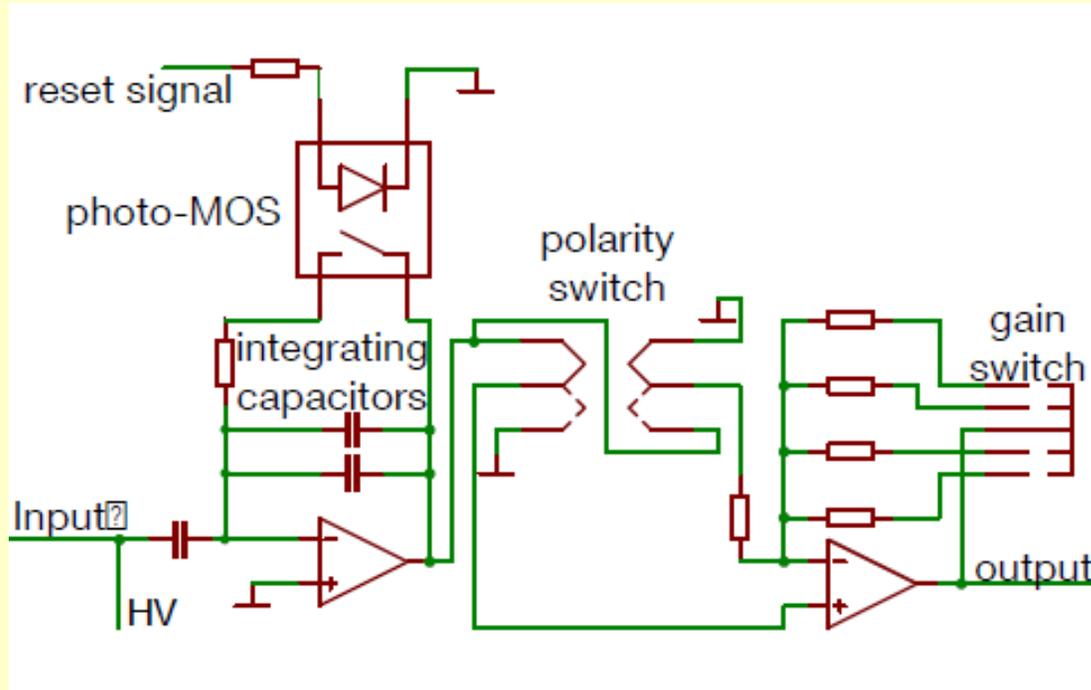
- ultra thin detectors for REX-ISOLDE
- tracking detectors for R3B
- prototype production
- further developments



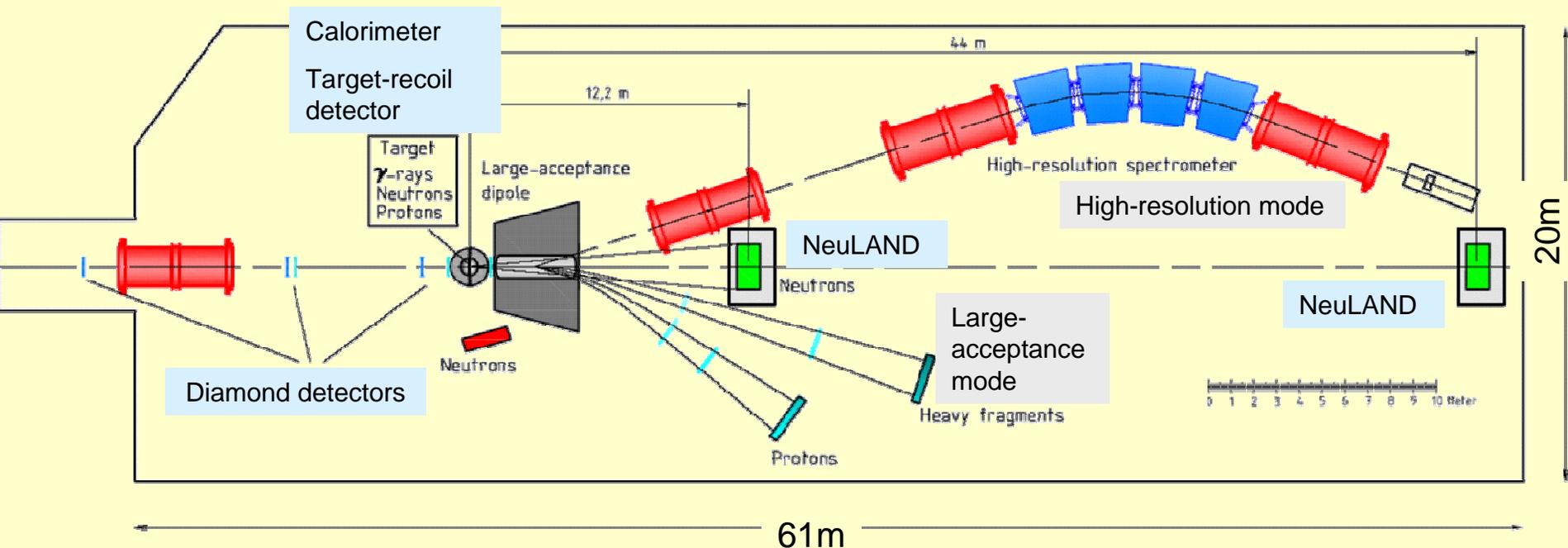
no space left
2.8 AMeV beam
radioactive beam
50 Hz 100 μ s long pulses
of 10^5 - 10^6 particles/s



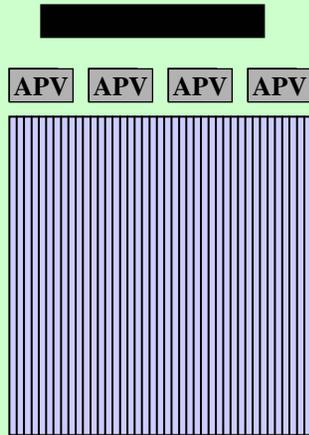
10 mm open diameter
 10-12 μm PC-CVD film
 9 segments
 silicon ring for mechanical stability
 calibration by single particle counting
 or at high intensity, Faraday Cup (10^8 1/s)



from Diamond Materials

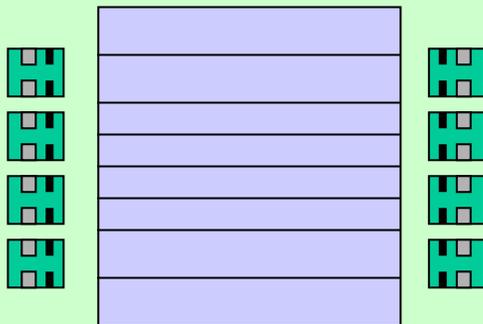


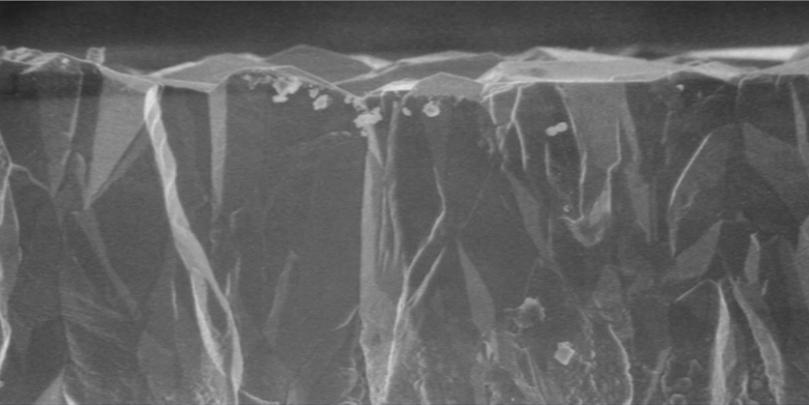
Measurement of all kinematic variables in a HI reaction
 secondary beams have a large spot size (4 x 5 cm)!
 → high resolution tracking to the target,
 radiation hard (SFRS) $10^6 \text{ cm}^{-1} \text{ s}^{-1}$
 material budget limits the resolution and rate capability of the
 whole spectrometer. (Multiple scattering in the last tracking layer)



metallization layer:

- 50 x 50 mm, PC-CVDD
- $d = 150 \mu\text{m}$ (thinner material is hard to handle)
- Al layer with lithographic structures
- x : $200 \mu\text{m}$ pitch (limited by multiple scattering)
- y : 1mm pitch for optional TOF
- only digital position information (PC-CVDD)
- multiplexed readout in vacuum (power consumption)
- event Rate up to $10^5 @ 10^7$ 1/s





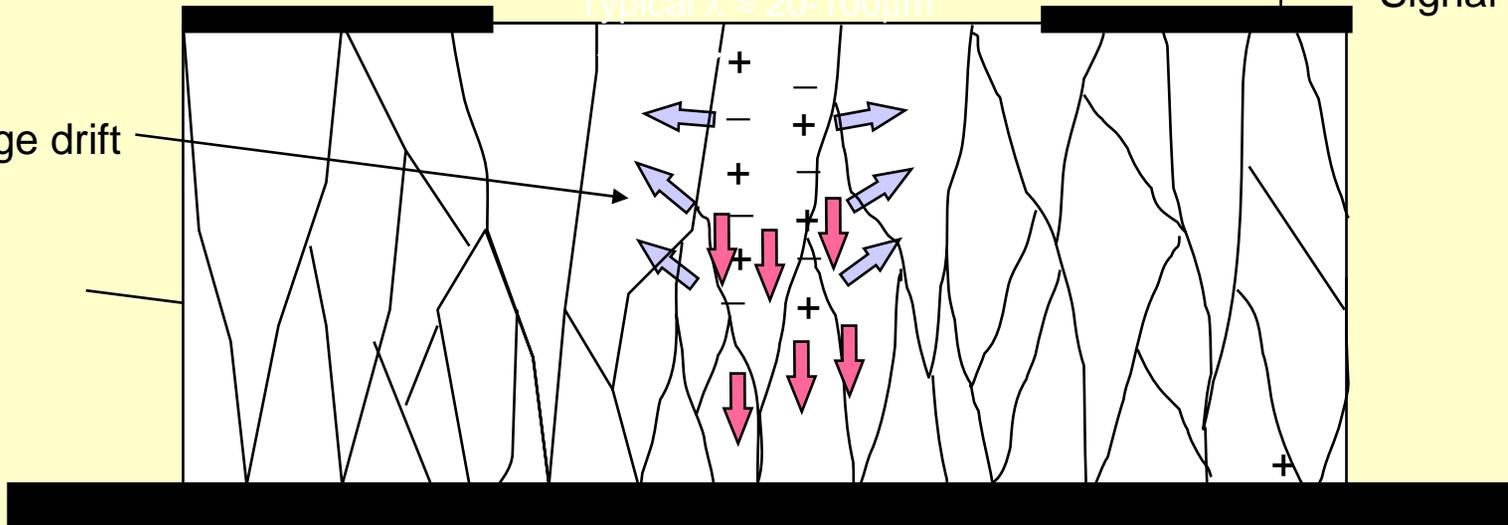
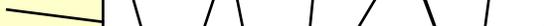
Inter-electrode gap $L \approx 50\mu\text{m}$



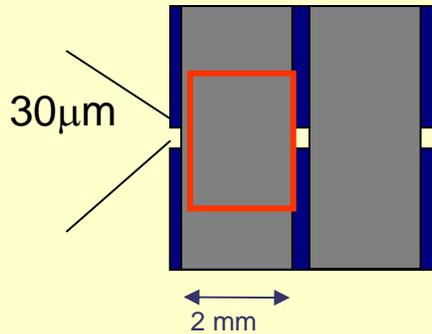
Typical $\lambda \approx 20\text{-}100\mu\text{m}$

Negative Bias
Signal Output

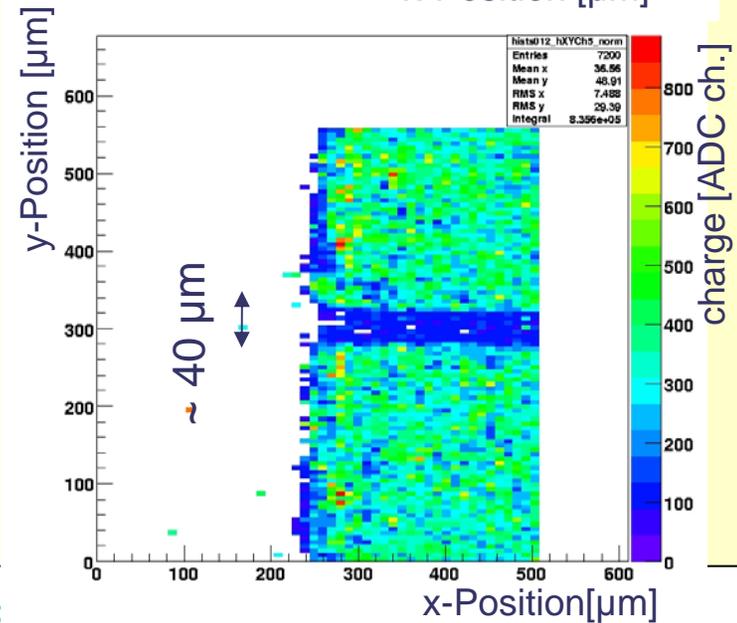
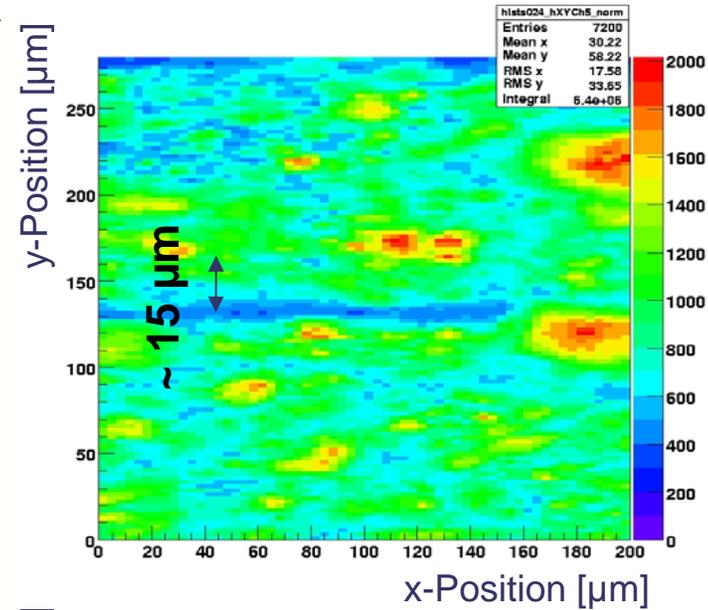
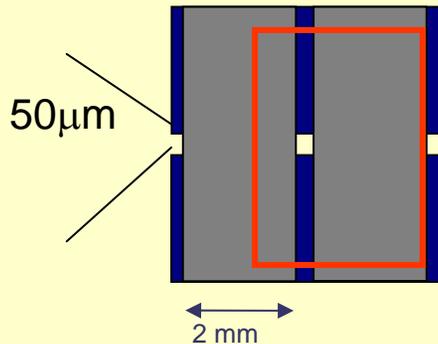
Charge drift



measurement with the Munich heavy ion micro beam

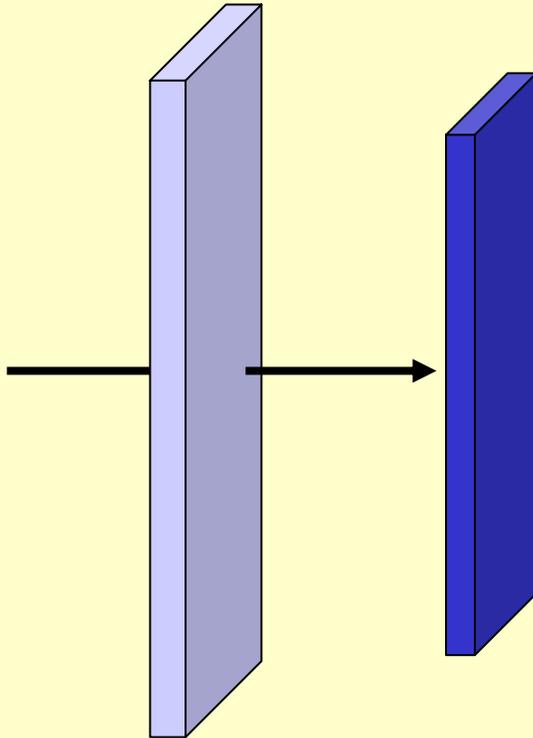


20 µm gaps should be fine



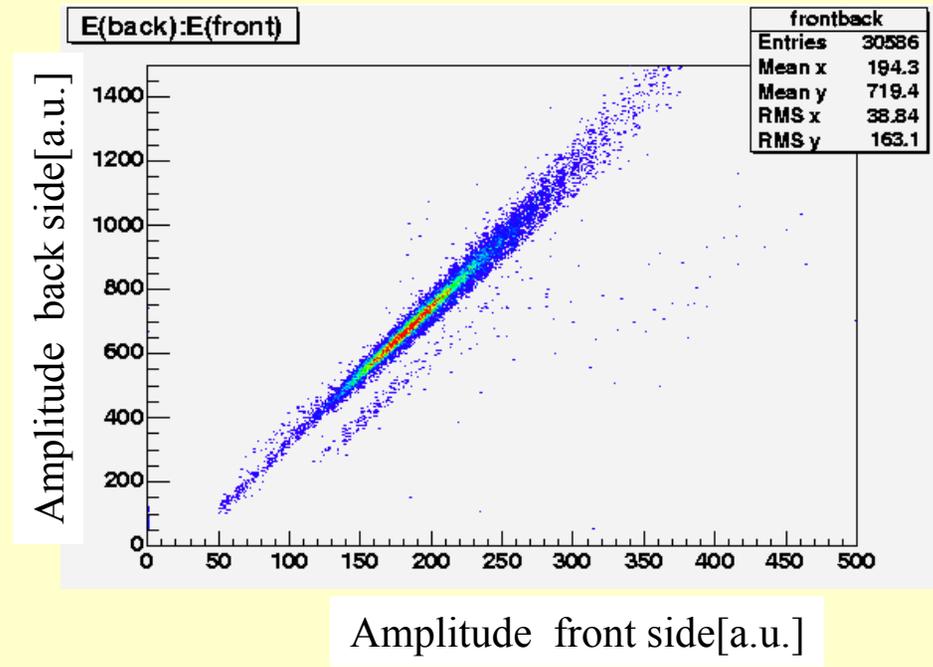
50 μm diamond
100 μm diamond

Si – diode
Trigger



Beam: 120 MeV ^{16}O
36 MeV ^6Li

efficiency 98%



**8 prototypes produced
4 operational
lithography under control**

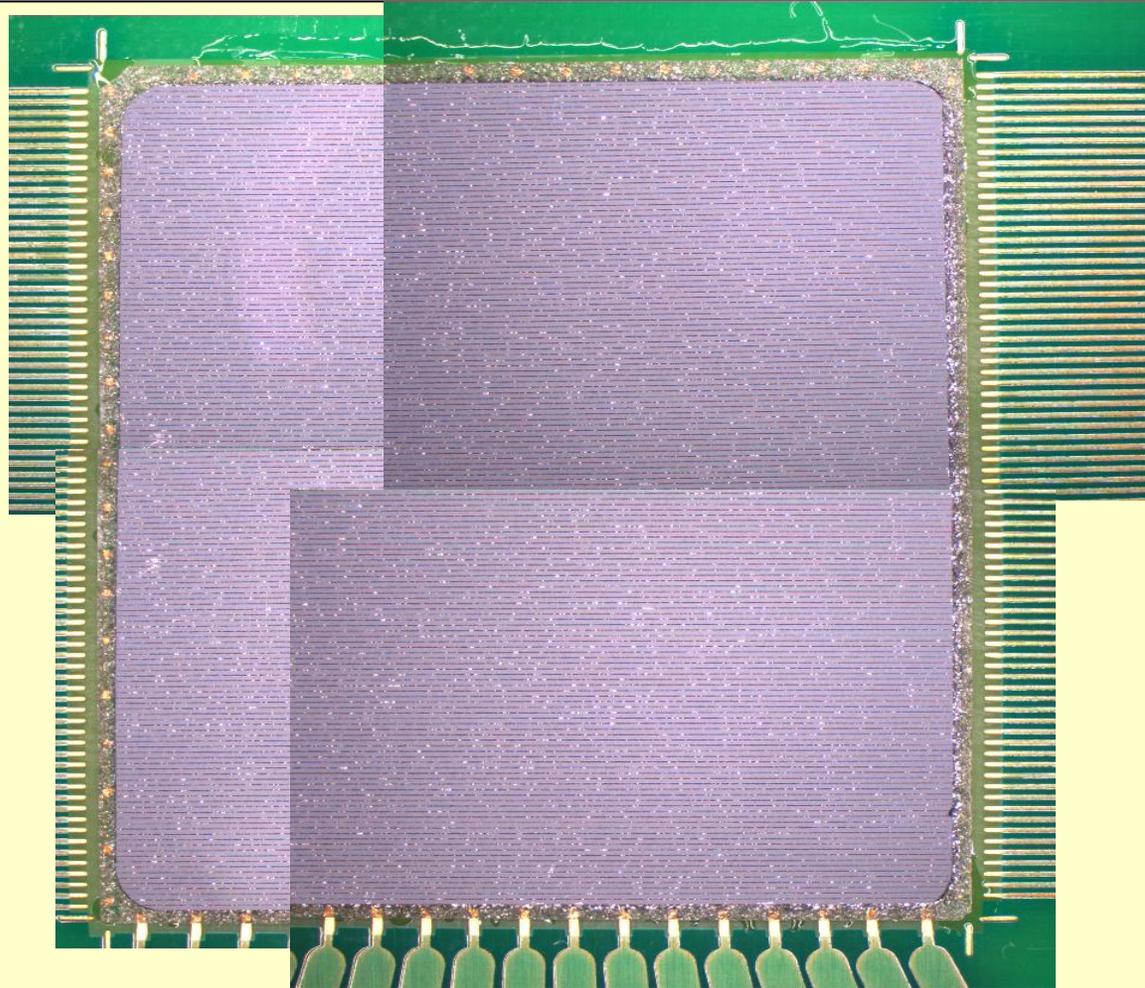
Front side:

128 strips

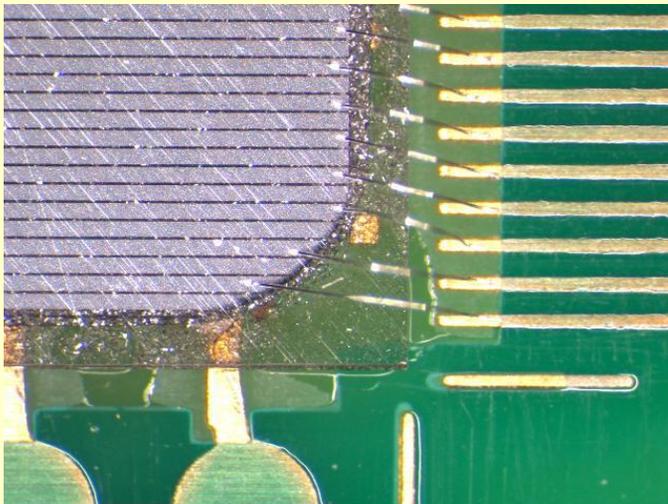
170 μm wide 20 μm gap

Backside:

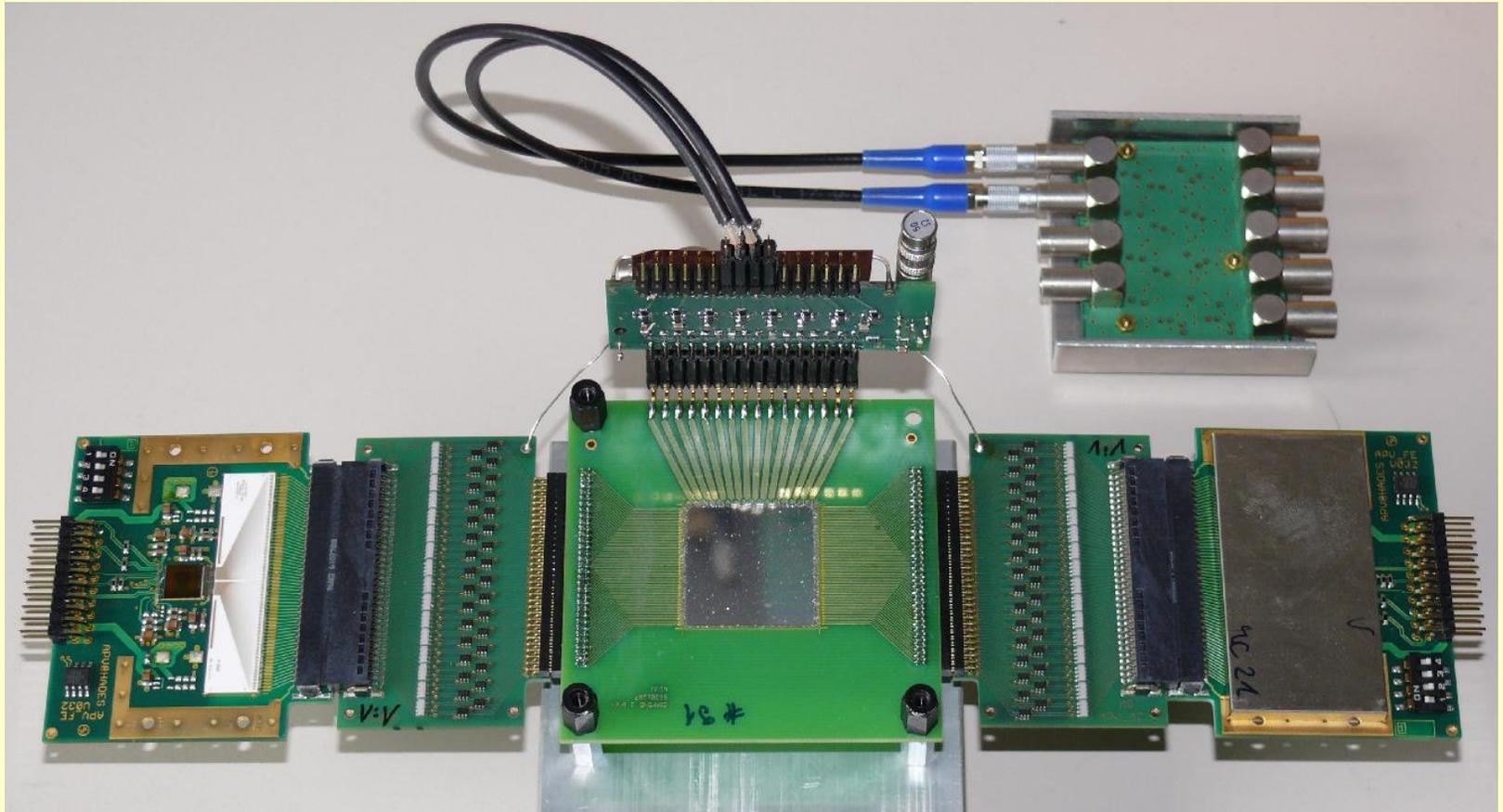
16 strips



25.4 mm



parts in vacuum



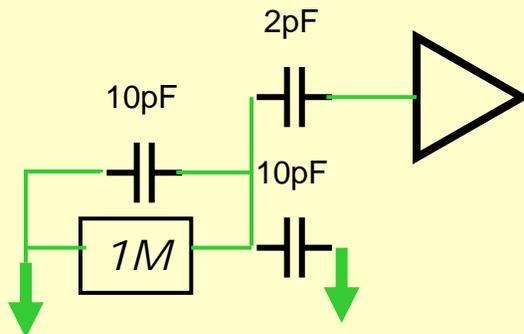
why can we use
readout electronics
designed for
silicon detectors
also in diamond?

$$W_{\text{dia}} \sim 4W_{\text{Si}}$$

$$d_{\text{dia}} \sim 0.5 d_{\text{Si}}$$

$$\text{CCD} \sim 0.1 d_{\text{dia}}$$

but we have HI
 $\Delta E \sim Z^2$
 $Z=32$ gains 1000



64 ch. Input
diode array
capacitive splitter

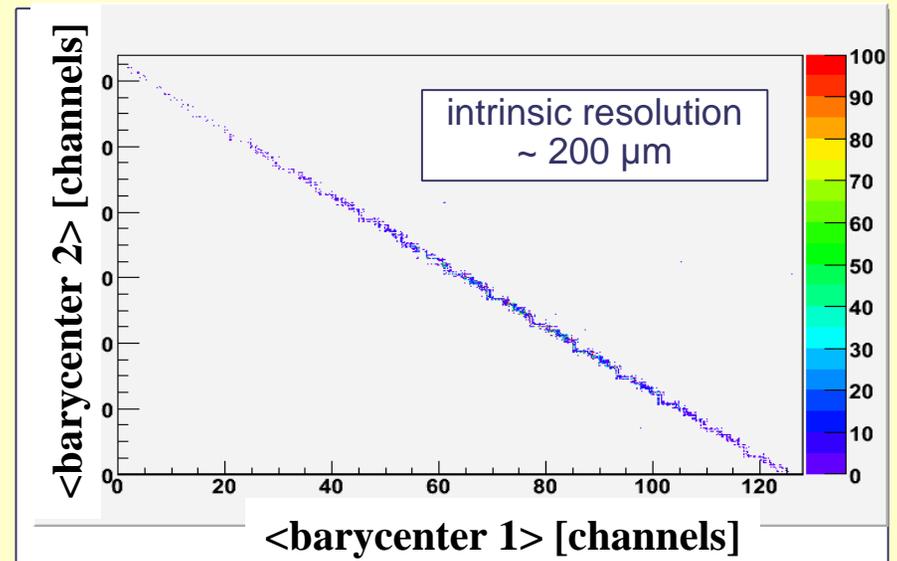
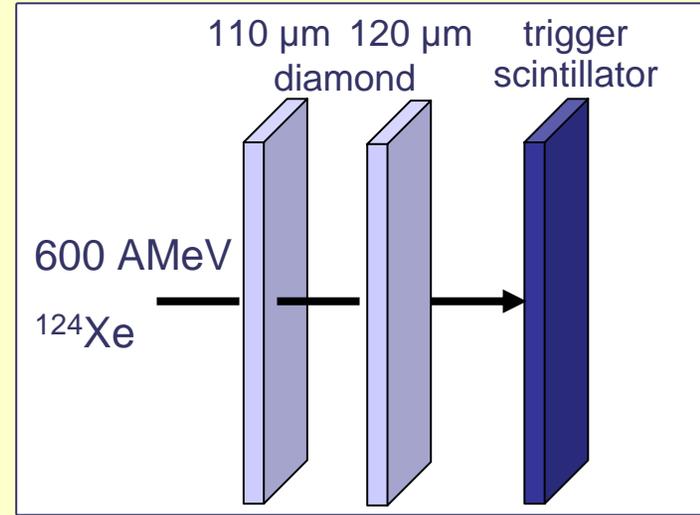
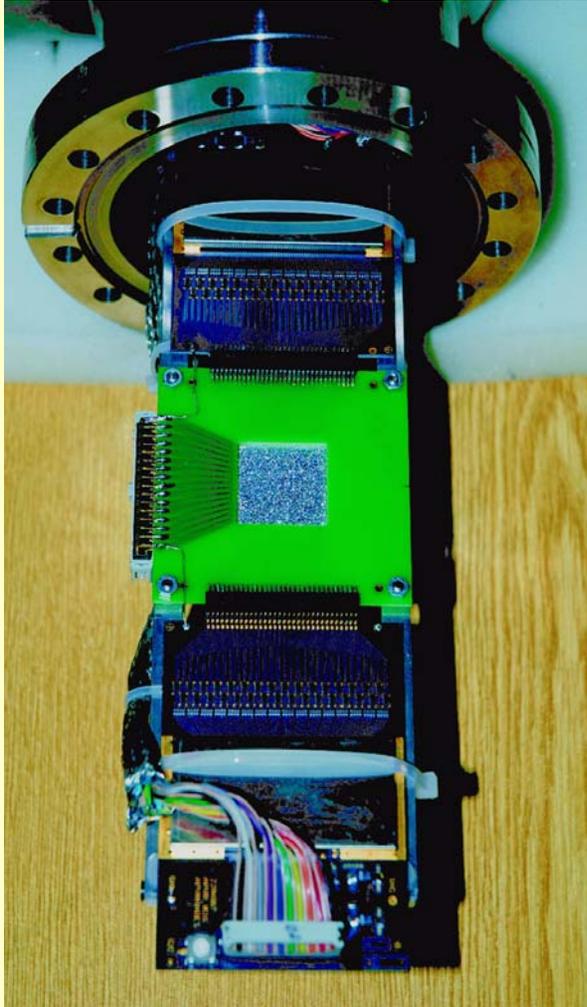
64 pin connector

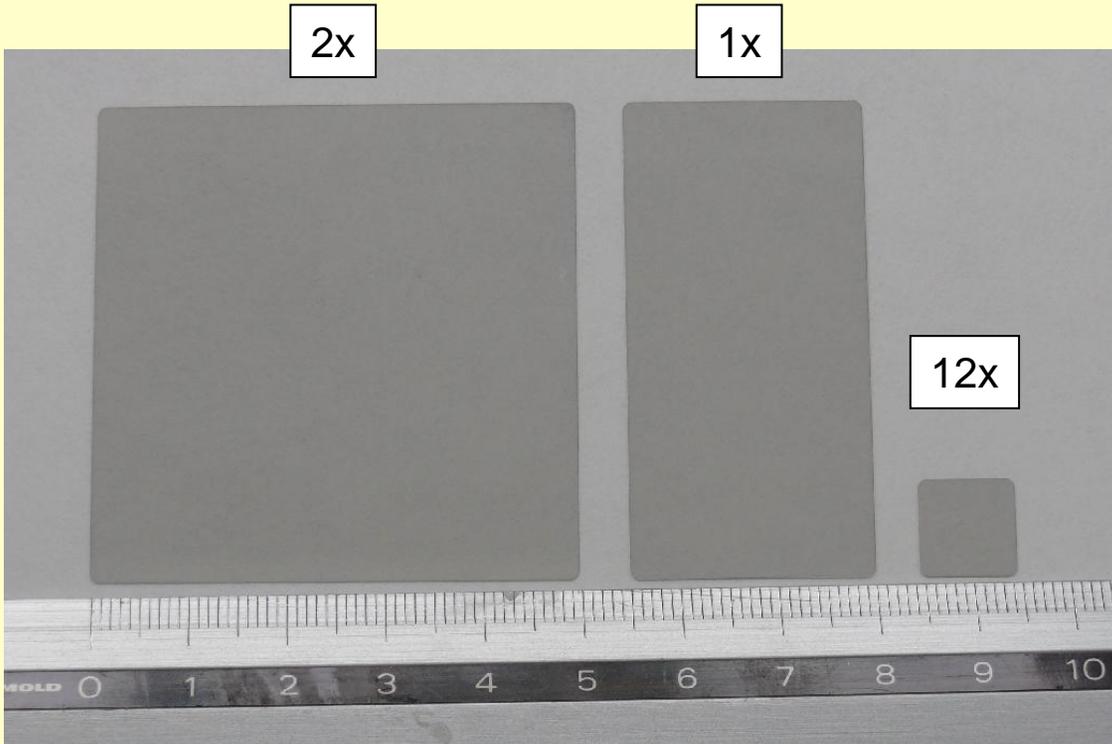
pitch adapter

APV

ADC and control
interface







150mm material
just to limit the risk

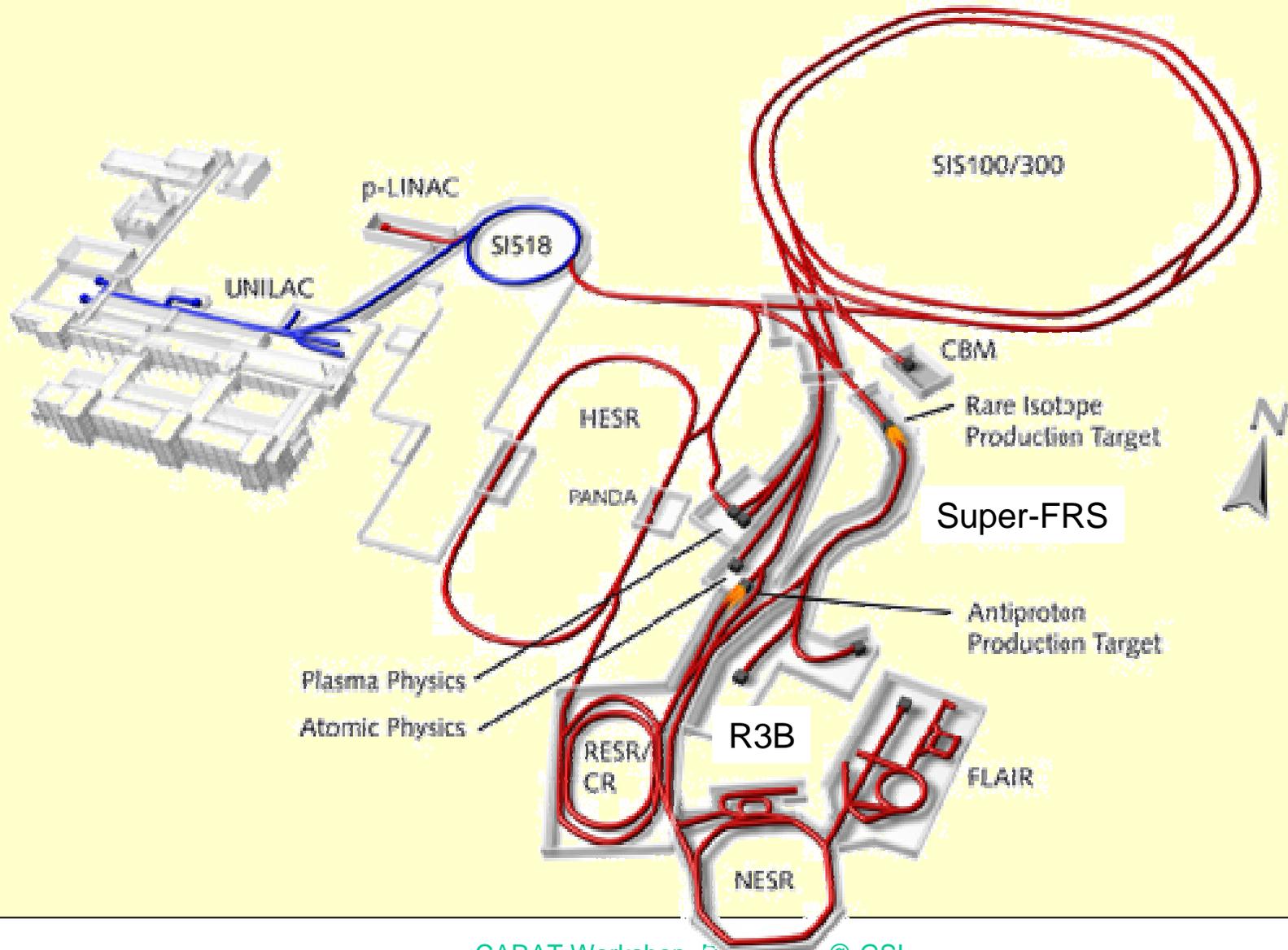
minimize the risk during and after production

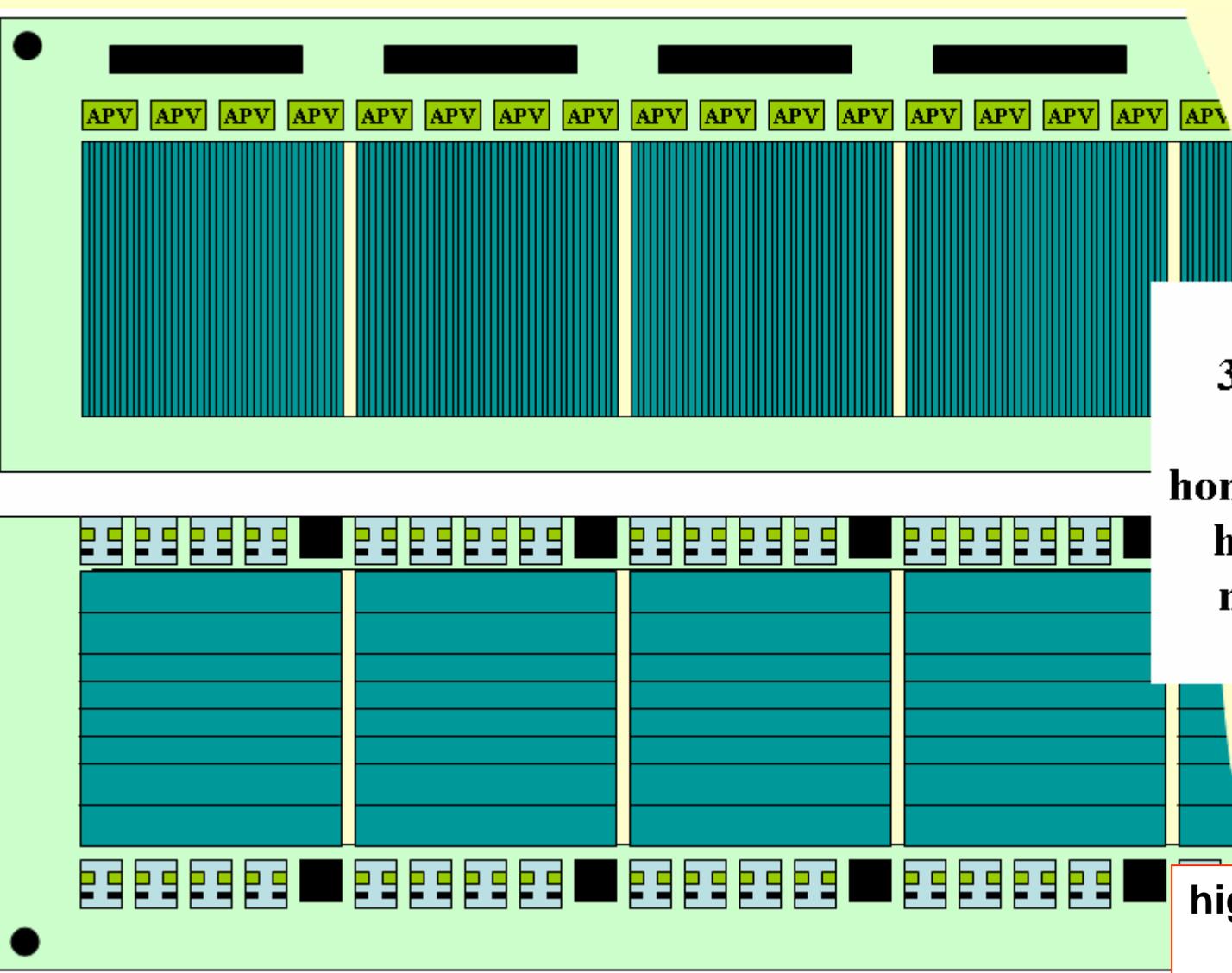
Verify effect of DLC coating (summer 2010) – no effect??

Finalize readout concept with medium size detectors

Further investigation on fast readout for FRS applications.

Full system test in 2011 (FRS000)

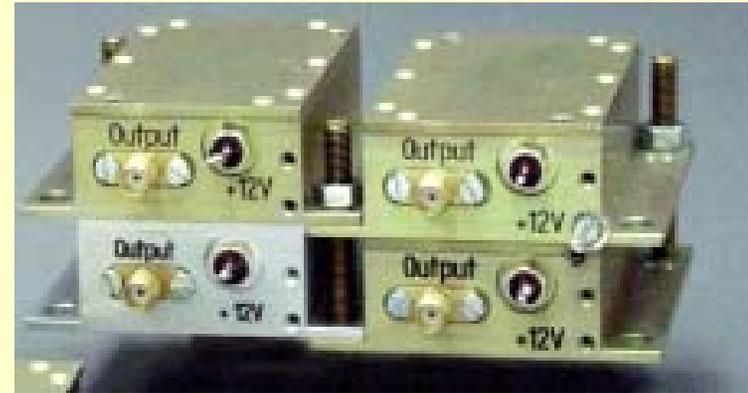
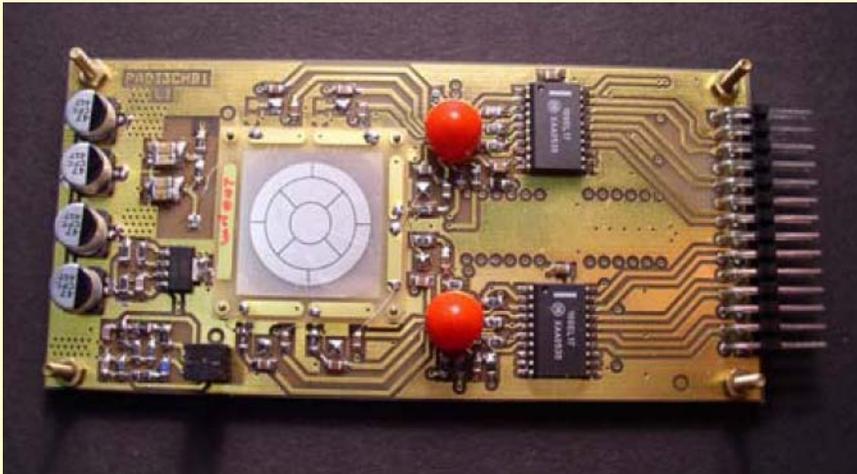




8 detectors
3000 channels
zero gap?
homogeneous layer
high efficiency
multi purpose
in vacuum

high resolution TOF
@ 10^7 needed

DBA II, DBA III, DBA4,
P. Moritz, GSI development

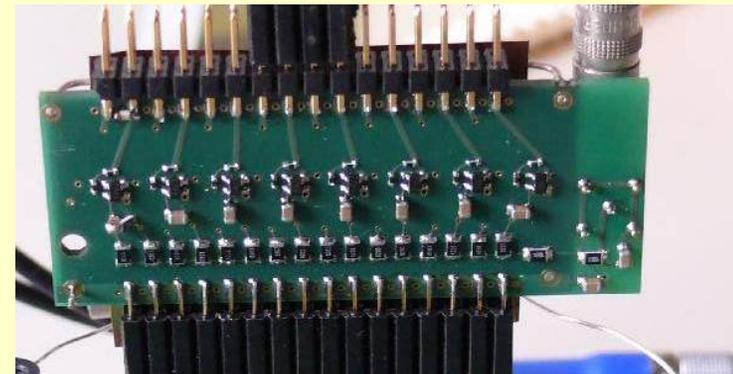


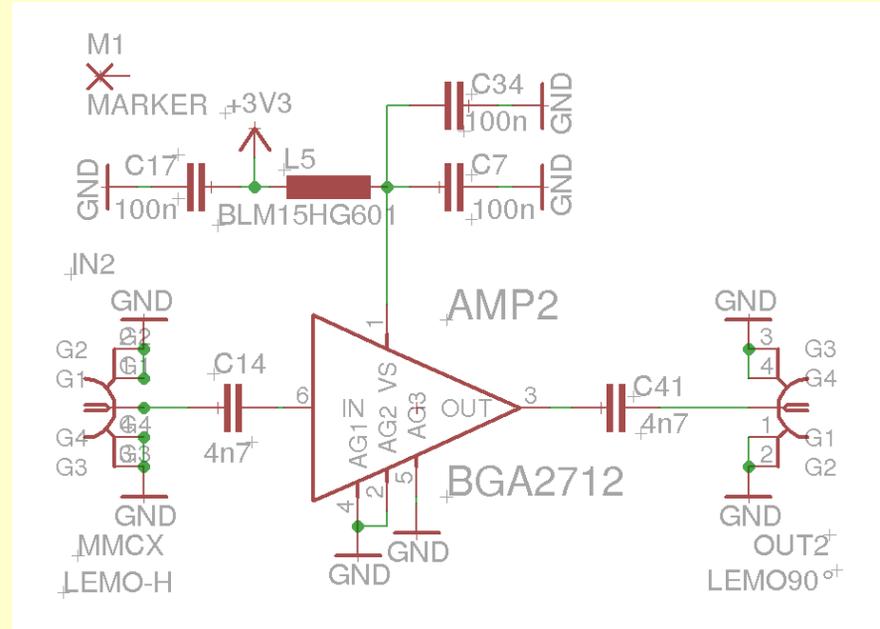
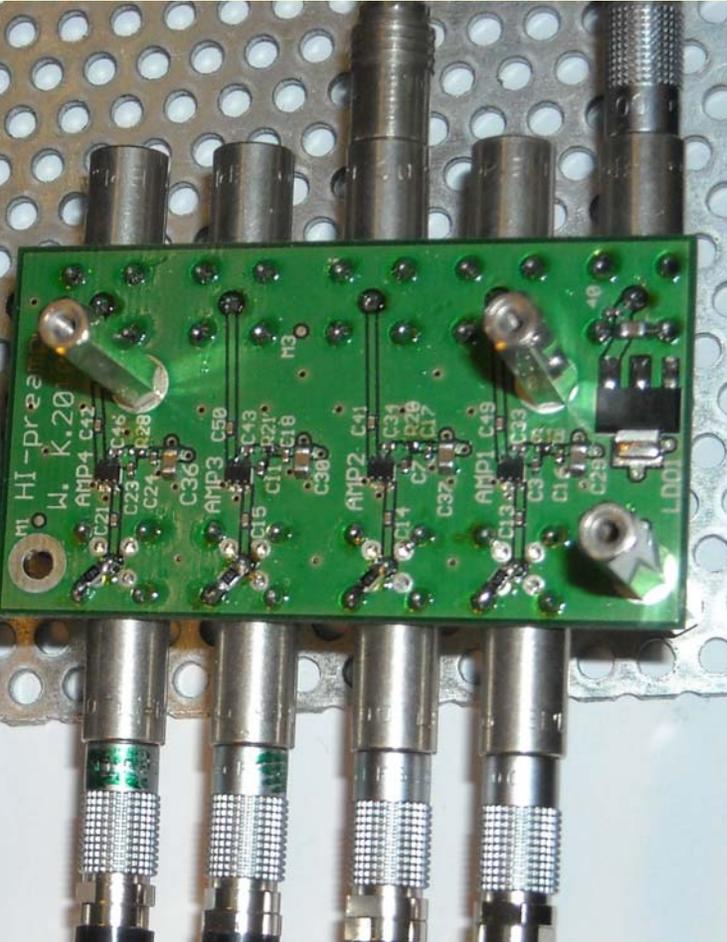
HADES diamond readout
W. Koenig, GSI development

PADI, a fast Preamplifier – Discriminator
for Time-of-Flight Measurements

M. Ciobanu, N. Herrmann, K. D. Hildenbrand, M. Kiš, A.
Schüttauf
IEEE Conf. Proc. (2006)

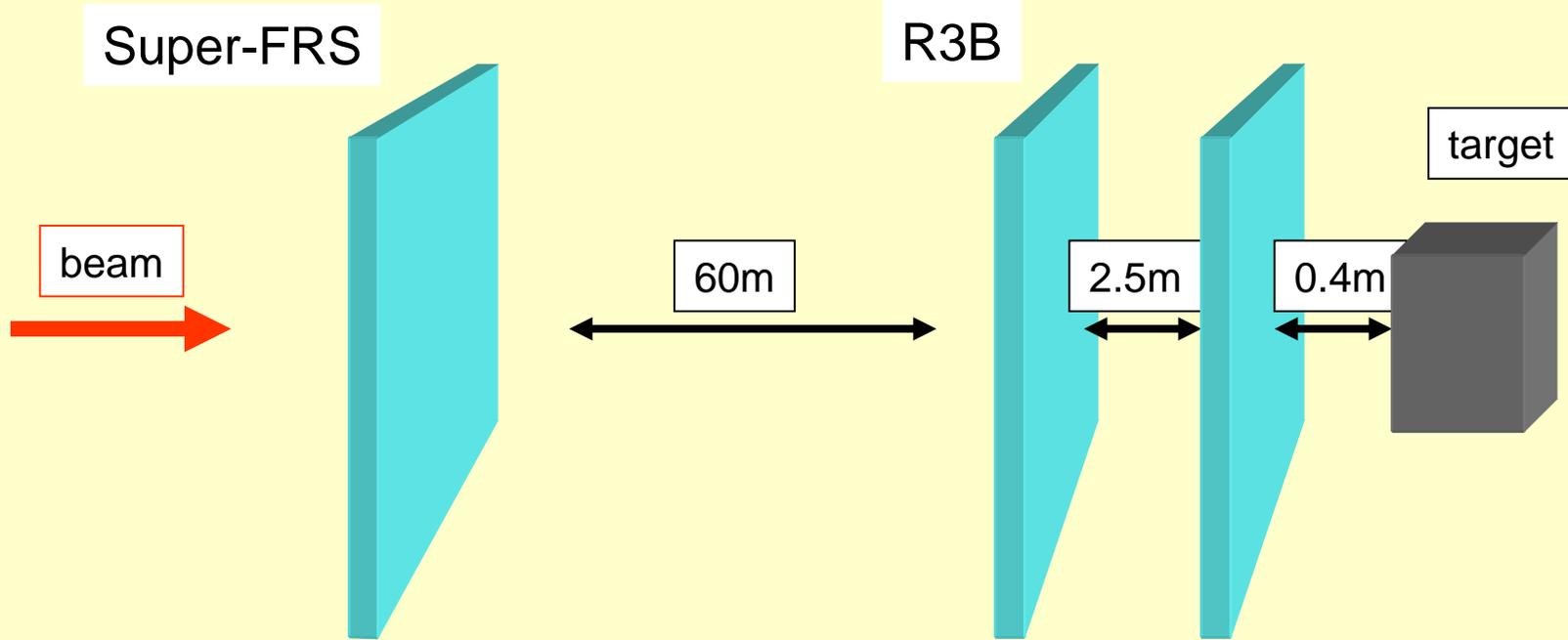
<http://www-rpc2010.gsi.de>





W.Koenig used in HADES 2010 -> J. Pietraszko

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance(max.)
BLM15HG601SN1□	600ohm±25%	1000ohm±40%	300mA	0.7ohm
BLM15HG102SN1□	1000ohm±25%	1400ohm±40%	250mA	1.1ohm
BLM15HB121SN1□	120ohm±25%	500ohm±40%	300mA	0.7ohm
BLM15HB221SN1□	220ohm±25%	900ohm±40%	250mA	1.0ohm
BLM15HD601SN1□	600ohm±25%	1400ohm±40%	300mA	0.85ohm
BLM15HD102SN1□	1000ohm±25%	2000ohm±40%	250mA	1.25ohm
BLM15HD182SN1□	1800ohm±25%	2700ohm±40%	200mA	2.2ohm



400 x 50 mm
 1st side x-readout (200 μ m)
 charge integrating (APV)
 2nd side y-readout (1.5mm)
 BBA (100ps resolution)

50 x 50 mm
 1st side x-readout (200 μ m)
 charge integrating (APV)
 2nd side y-readout (1.5mm)
 BBA (100ps resolution)

50 x 50 mm
 1st side x-readout (200 μ m pitch)
 2nd side y-readout (200 μ m pitch)
 Both sides charge integrating
 (APV)
 fits to multiple scattering

Next Milestones:

Test experiment 2011 @ GSI
TDR in 2011

Acknowledgements:

Sabine Schwertel, Wolfgang Koenig, Jurek Pietraszko and Chiara N.